onsemi

MOSFET - Power, Single N-Channel 30 V, 4.2 mΩ, 77 A

NVLJWS5D0N03CL

Features

- Small Footprint for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	30	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady State	$T_C = 25^{\circ}C$	۱ _D	77	А
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		55	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_{C} = 25^{\circ}C$	PD	45	W
		$T_{C} = 100^{\circ}C$		23	
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	۱ _D	18	А
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		13	
Power Dissipation		$T_A = 25^{\circ}C$	PD	2.5	W
$R_{\theta JA}$ (Notes 1, 2)		T _A = 100°C		1.2	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	317	А
Operating Junction and Storage Temperature Range			T _J , T _{stg}	−55 to +175	°C
Source Current (Body Diode)			۱ _S	37	А
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 4.8 A)			E _{AS}	101	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	3.3	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	61	

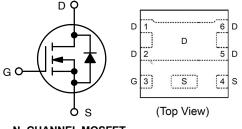
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

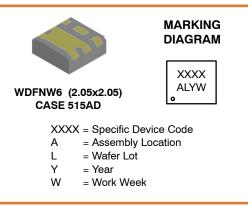
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX
30 V	4.2 mΩ @ 10 V	77 A
30 V	6.6 mΩ @ 4.5 V	

ELECTRICAL CONNECTION



N-CHANNEL MOSFET



ORDERING INFORMATION

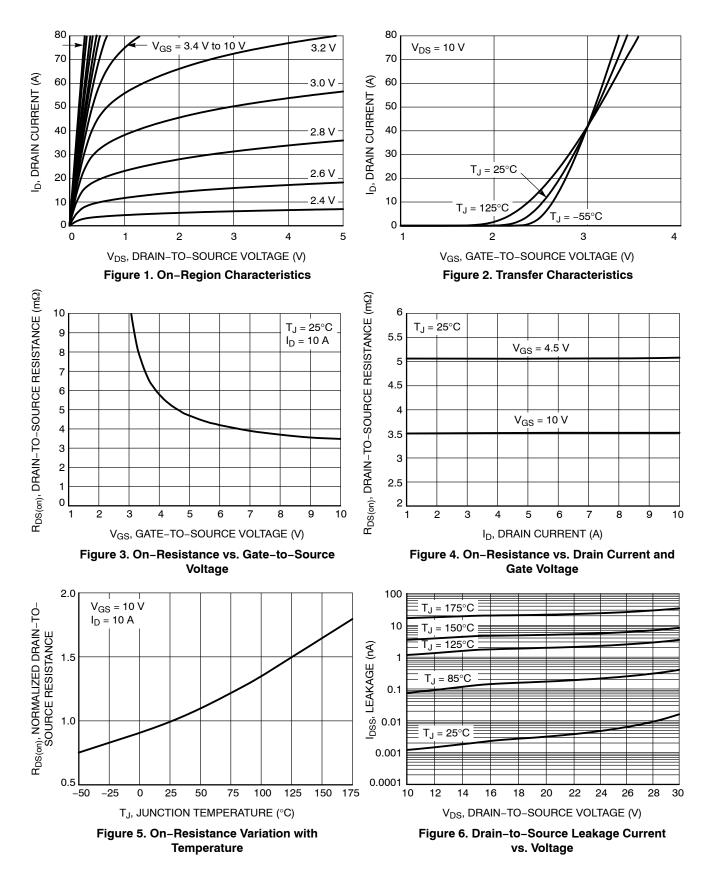
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

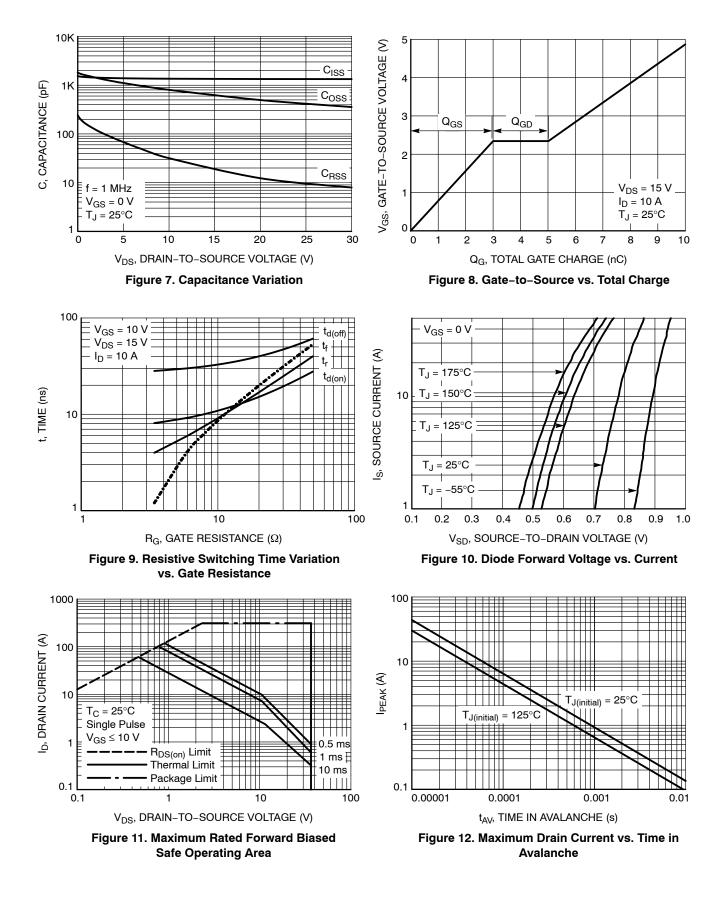
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS					•		
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = 250 μA		30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \mu$ A, ref to 25°C			14.4		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 30 V	T _J = 25°C			1	μΑ
			T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _G	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	1.2		2.0	V
Threshold Temperature Coefficient	V _{GS} /T _J	I _D = 250 μA, re	f to 25°C		-4.4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A			3.5	4.2	mΩ
		V _{GS} = 4.5 V, I	_D = 10 A		5.1	6.6	
Forward Transconductance	g fs	V _{DS} = 10 V, I _D = 10 A			44		S
CHARGES AND CAPACITANCES							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 15 V, f = 1.0 MHz			1350		pF
Output Capacitance	C _{oss}				650		
Reverse Transfer Capacitance	C _{rss}				20		
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 10 A			9.0		
Total Gate Charge	Q _{G(TOT)}	$V_{GS} = 10 \text{ V}, V_{DS} = 15 \text{ V},$ $I_D = 10 \text{ A}$			20		
Threshold Gate Charge	Q _{G(TH)}				1.8		nC
Gate-to-Source Charge	Q _{GS}				3.0		
Gate-to-Drain Charge	Q _{GD}				2.0		
Plateau Voltage	V _{GP}	1	-		2.3		V
SWITCHING CHARACTERISTICS (N	ote 5)	-			•		
Turn-On Delay Time	t _{d(on)}				9.0		ns
Rise Time	t _r	V _{CS} = 10 V. V _D	п = 15 V.		4.0		1
Turn-Off Delay Time	t _{d (off)}	$\begin{array}{l} V_{GS} = 10 \; V, V_{DD} = 15 \; V, \\ I_{D} = 10 \; A, R_{G} = 6 \; \Omega \end{array}$			30		1
Fall Time	t _f				6.0		1
DRAIN-SOURCE DIODE CHARACTE	RISTICS	-			•		
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 10 A$	$T_J = 25^{\circ}C$		0.78	1.2	V
			T _J = 125°C		0.64		1
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dl _S /dt = 100 A/µs, I _S = 10 A			35		ns
Charge Time	ta				17		1
Discharge Time	t _b				18		1
Reverse Recovery Charge	Q _{RR}				23		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2%.
5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

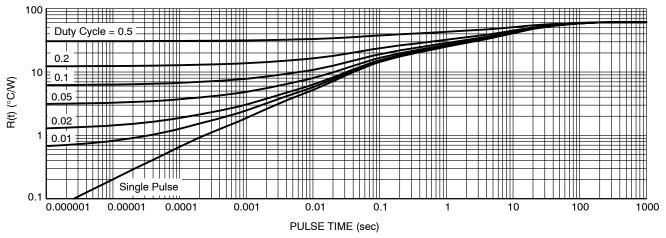


Figure 13. Transient Thermal Impedance

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVLJWS5D0N03CLTAG	5D0N	WDFNW6 (Pb-Free, Wettable Flanks)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

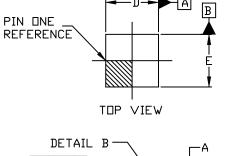
WDFNW6 2.05x2.05, 0.65P

CASE 515AD **ISSUE O**

NDTES

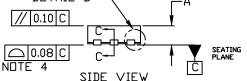


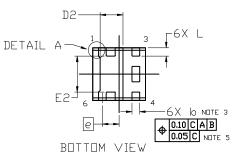
- 2.
- CONTROLLING DIMENSION: MILLIMETERS DIMENSION & APPLIES TO PLATED TERMINALS AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE З. TERMINAL TIP.
- COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL 4. AS THE TERMINALS.
- POSITIONAL TOLERANCE APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS. 5.

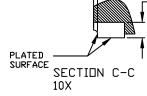


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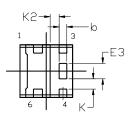
A







L3-

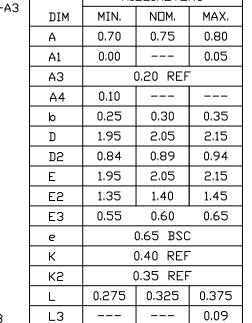


BOTTOM VIEW (SUPPLEMENTAL)

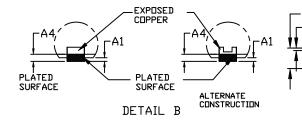
DETAIL A

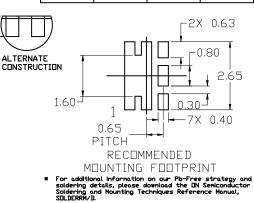
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